D OR P PACKAGE (TOP VIEW)

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- Meets or Exceeds the Requirements of TIA/EIA-422-B, TIA/EIA-485-A, and ITU **Recommendation V.11**
- Bus Voltage Range ... -7 V to 12 V
- Positive- and Negative-Current Limiting
- Driver Output Capability . . . 60 mA Max
- **Driver Thermal-Shutdown Protection**
- Receiver Input Impedance . . . 12 k Ω Min
- Receiver Input Sensitivity . . . ±200 mV
- Receiver Input Hysteresis ... 50 mV Typ
- **Operates From Single 5-V Supply**
- Low Power Requirements

description

The SN75179B is a differential driver and receiver pair designed for balanced transmission-line applications and meets TIA/EIA-422-B, TIA/EIA-485-A, and ITU Recommendation V.11. It is designed to improve the performance of full-duplex data communications over long bus lines.

The SN75179B driver output provides limiting for both positive and negative currents. The receiver features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of ±200 mV over a common-mode input voltage range of -7 V to 12 V. The driver provides thermal shutdown for protection from line fault conditions. Thermal shutdown is designed to occur at a junction temperature of approximately 150°C. The SN75179B is designed to drive current loads of up to 60 mA maximum.

The SN75179B is characterized for operation from 0°C to 70°C.

Function Tables

DRIVER

INPUT	OUTI	PUTS
CD.	Y	Z
HOM	Ĥ	L
(0Y.L	L	Н

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đ	RECEIVER	1
	DIFFERENTIAL INPUTS A – B	OUTPUT R
J	$V_{ID} \ge 0.2 V$	Н
	$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$?
	$V_{ID} \leq -0.2 V$	T.L
	Open	?

H = high level, L = low level, ? = indeterminate



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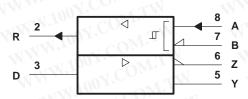
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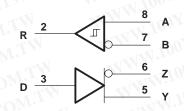
logic symbol[†]

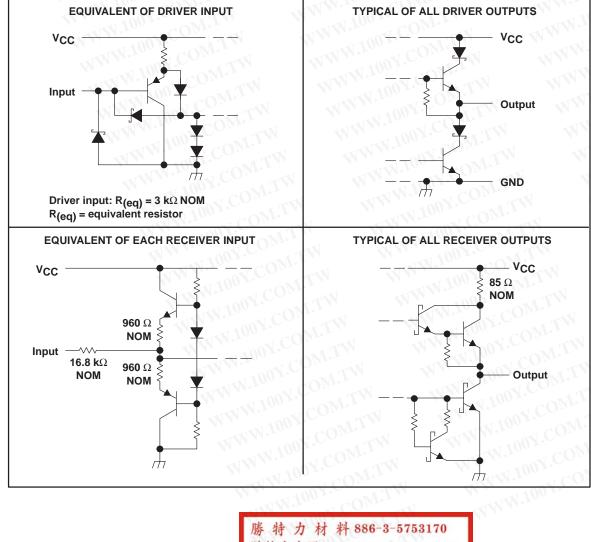


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

schematics of inputs and outputs

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1)	
Voltage range at any bus terminal	– 10 V to 15 V
Differential input voltage, VID (see Note 2)	
Package thermal impedance, θ _{JA} (see Note 3): D package	197°C/W
P package	
Storage temperature range, T _{stg} Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.

2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

WY 100X. OM.TW	W 1100 CON. 1	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	T.M. TIDOY. CONT.T	4.75	5	5.25	V
High-level input voltage, VIH	Driver	2	V	W.	V
Low-level input voltage, VIL	Driver	M		0.8	V
Common-mode input voltage, VIC	TW.100 COM	-7‡		12	V
Differential input voltage, VID	TW WWW 100Y.C	TN		±12	V
Lligh lavel autout autout la Martin COM	Driver	WTA		-60	mA
High-level output current, IOH	Receiver	11.	N	-400	μA
1 and 100 and 1	Driver			60	
Low-level output current, IOL	Receiver	T.M.	NA	8	mA
Operating free-air temperature, TA	Non War War	0	WT	70	°C

[‡] The algebraic convention, where the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage.

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DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CC	NDITIONS	MIN	TYP [†]	MAX	UNIT
VIK	Input clamp voltage	l _l = -18 mA	Y.OM.TW	N.	.W.1	-1.5	V
VO	Output voltage	IO = 0	N.C. MIN	0		6	V
VOD1	Differential output voltage	I ^O = 0	NT. TON	1.5	MM.	6	V
VOD2	Differential output voltage	R _L = 100 Ω,	See Figure 1	1/2VOD1 or 2 [‡]	WWW	N.100	v
	WWW.LCONY.COM	R _L = 54 Ω,	See Figure 1	1.5	2.5	5	V
VOD3	Differential output voltage	See Note 4	N.L. COM	1.5	WV	5	V.
∆ V _{OD}	Change in magnitude of common-mode output voltage§	WW WW	W.100Y.COM	TW	W	±0.2	10VI
Voc	Common-mode output voltage	$R_L = 54 \Omega$ or 100 Ω,	See Figure 1	N.T.W		3 -1	1.100
	Change in magnitude of common-mode output voltage§	WIN W	WWW.1001.CC	WI.I.W		±0.2	v
IO	Output current	V _{CC} = 0,	$V_0 = -7 V \text{ to } 12 V$	O.M.	I	±100	μA
Ιн	High-level input current	V _I = 2.4 V	WW.100	-0 ^N	a 1	20	μA
۱ _{IL}	Low-level input current	V _I = 0.4 V	W	T.Mor		-200	μA
	Short circuit output ouront	$V_{O} = -7 V$	WW TANDY			-250	mA
los	Short-circuit output current	$V_0 = V_{CC} \text{ or } 12 \text{ V}$		COm	W	250	mA
ICC	Supply current (total package)	No load	W.100	- CON	57	70	mA

[†] All typical values are at $V_{CC} = 5$ V and $T_A = 25^{\circ}C$.

⁴ The minimum V_{OD2} with 100- Ω load is either 1/2 V_{OD2} or 2 V, whichever is greater.

S Δ|VOD| and Δ|VOC| are the changes in magnitude of VOD and VOC, respectively, that occur when the input changes from a high level to a low level.

NOTE 4: See TIA/EIA-485-A, Figure 3.5, Test Termination Measurement 2.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
^t d(OD)	Differential output delay time	Die 54.0	.100	15	22	ns
^t t(OD)) Differential output transition time $R_L = 54 \Omega$, See Figure 3	N.100	20	30	ns	
		Symbol Equivalents				

Symbol Equivalents

DATA-SHEET PARAMETER	TIA/EIA-422-B	TIA/EIA-485-A
Vo	V _{oa} , V _{ob}	V _{oa} , V _{ob}
VOD1	Vo	Vo
VOD2	V _t (R _L = 100 Ω)	V _t (R _L = 54 Ω)
VOD3	MWW.Io-	Vt (Test Termination Measurement 2)
Δ V _{OD}	$ V_t - \overline{V}_t $	$ V_t - \overline{V}_t $
Voc	V _{os}	V _{os}
	$ V_{OS} - \overline{V}_{OS} $	$ V_{OS} - \overline{V}_{OS} $
los	I _{sa} , I _{sb}	
IO	I _{xa} , I _{xb}	l _{ia} , l _{ib}



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RECEIVER SECTION

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CONDITIONS				TYPT	MAX	UNIT
VIT+	Positive-going input threshold voltage	V _O = 2.7 V,	$I_{O} = -0.4 \text{ mA}$			100 r.	0.2	V
VIT-	Negative-going input threshold voltage	V _O = 0.5 V,	I _O = 8 mA	V V	-0.2‡	100		V
V _{hys}	Hysteresis voltage (V _{IT+} – V _{IT} _)	WWW.L	CONT.	W/	WW	50	N.CU	mV
Vон	High-level output voltage	V _{ID} = 200 mV,	I _{OH} = -400 μA,	See Figure 2	2.7	M'In.	ST C	V
Vol	Low-level output voltage	$V_{ID} = -200 \text{ mV},$	IOL = 8 mA,	See Figure 2	N	1.10	0.45	V
1.	Line of the second s	Other input at 0.1/					001	
1	Line input current	Other input at 0 V,	See Note 5	$V_{I} = -7 V$	N	MA.	-0.8	C ^{mA}
r _i	Input resistance		W.100 CO	N.	12	WW	Too	kΩ
los	Short-circuit output current	The Max	W 1001.	M.T.Y	-15		-85	mA
ICC	Supply current (total package)	No load	N TOOX.C	WILL		57	70	mA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] The algebraic convention, where the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

NOTE 5: Refer to TIA/EIA-422-B for exact conditions.

switching characteristics, V_{CC} = 5 V, T_A = 25° C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PLH	Propagation delay time, low- to high-level output	$V_{ID} = -1.5 V$ to 1.5 V,		19	35	ns
^t PHL	Propagation delay time, high- to low-level output	$C_L = 15 \text{ pF},$ See Figure 4	1.1	30	40	ns

PARAMETER MEASUREMENT INFORMATION

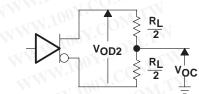


Figure 1. Driver V_{DD} and V_{OC}

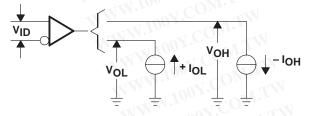
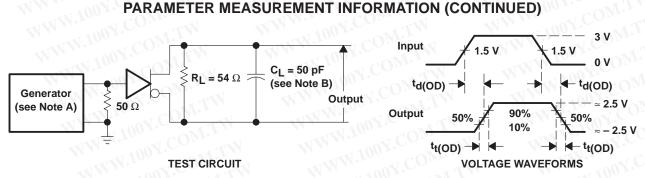


Figure 2. Receiver VOH and VOL



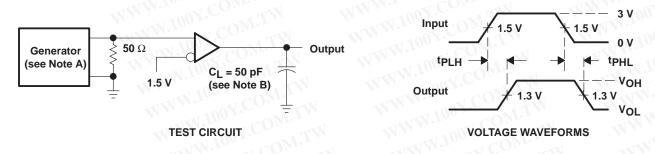


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- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, t_f \leq 6 ns, t_f \leq 6 ns, Z_O = 50 Ω .
 - B. \dot{C}_L includes probe and jig capacitance.





- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, t_r \leq 6 ns, t_f \leq 6 ns, Z_O = 50 Ω .
 - B. C_L includes probe and jig capacitance.

Figure 4. Receiver Test Circuit and Voltage Waveforms

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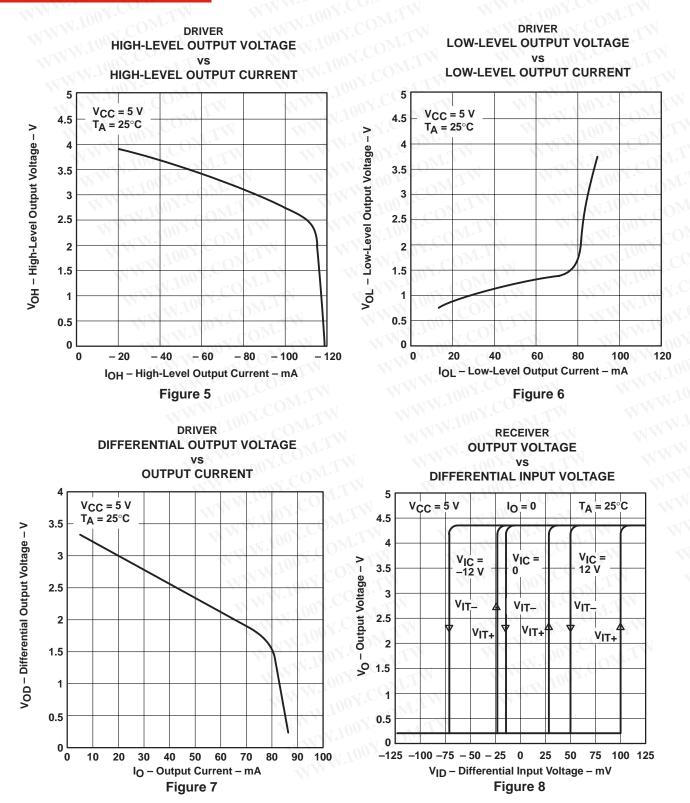


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SN75179B DIFFERENTIAL DRIVER AND RECEIVER PAIR

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TYPICAL CHARACTERISTICS

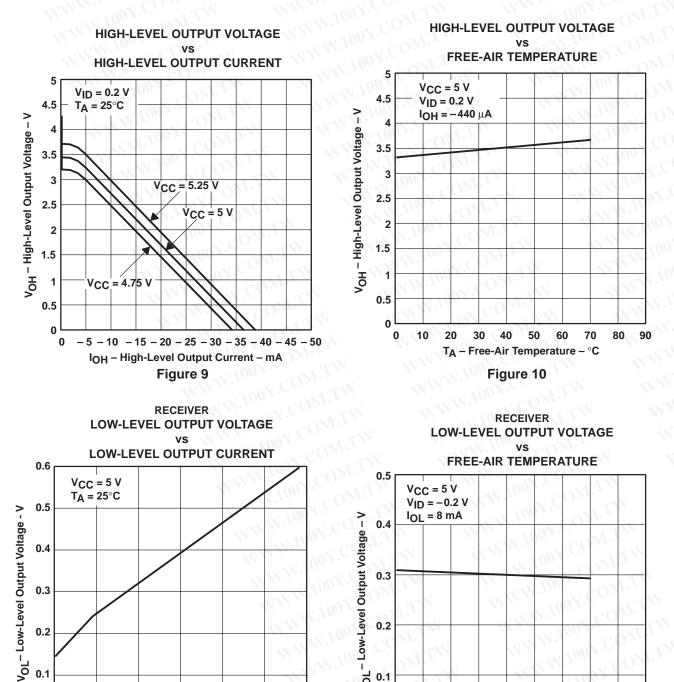




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TYPICAL CHARACTERISTICS



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0 10 20

30 40 50

T_A – Free-Air Temperature – °C

Figure 12

60

70

80

90

0.2

0.1

0

0

5

10

15

IOL - Low-Level Output Current - mA

Figure 11

20

25

30



24-Oct-2006

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75179BD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75179BDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75179BDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75179BDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75179BP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75179BPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75179BPSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75179BPSRE4	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
					A 1 8	V ²		

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

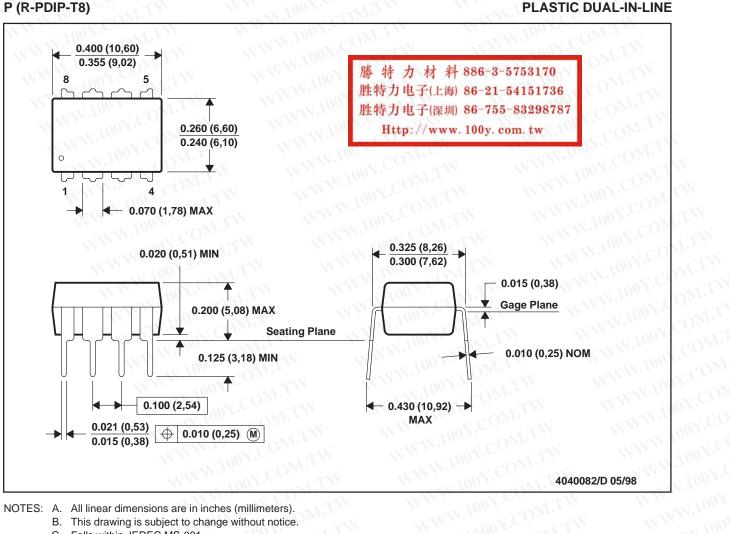
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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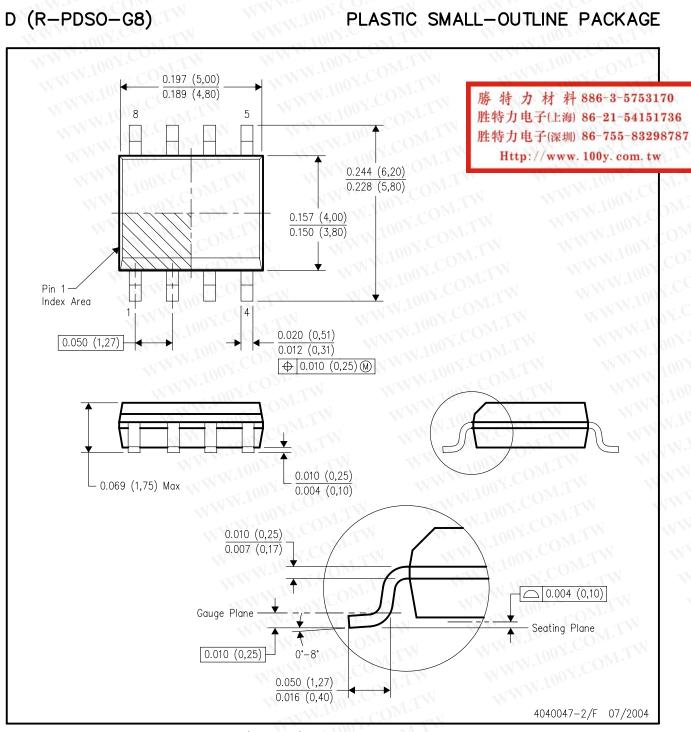
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- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001

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NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AA.

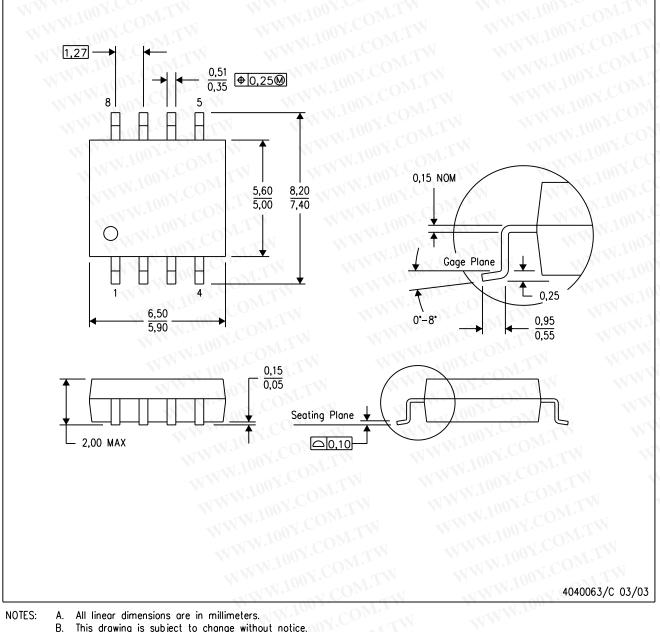




PLASTIC SMALL-OUTLINE PACKAGE

MECHANICAL DATA

PS (R-PDSO-G8)



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- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15. WWW.100Y.COM WWW.10



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